

# LPP Sources for HVM EUV Lithography

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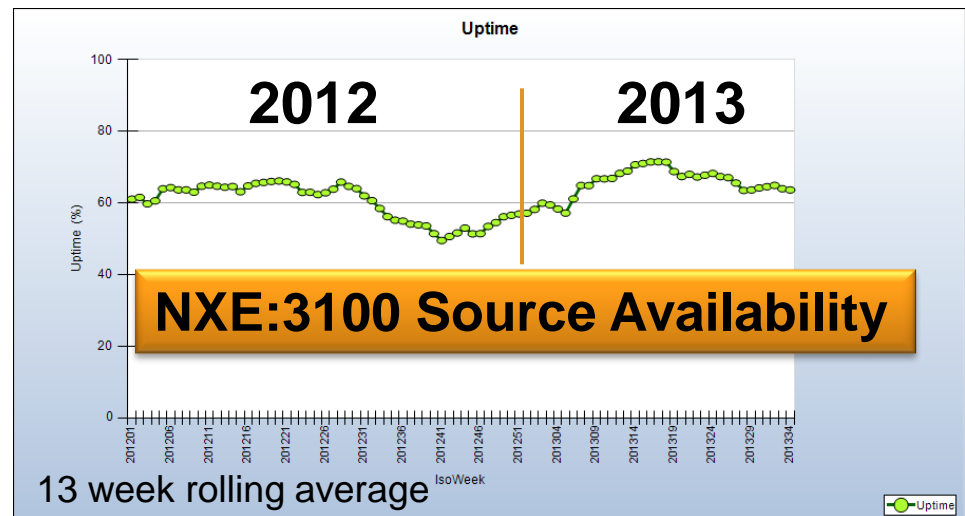
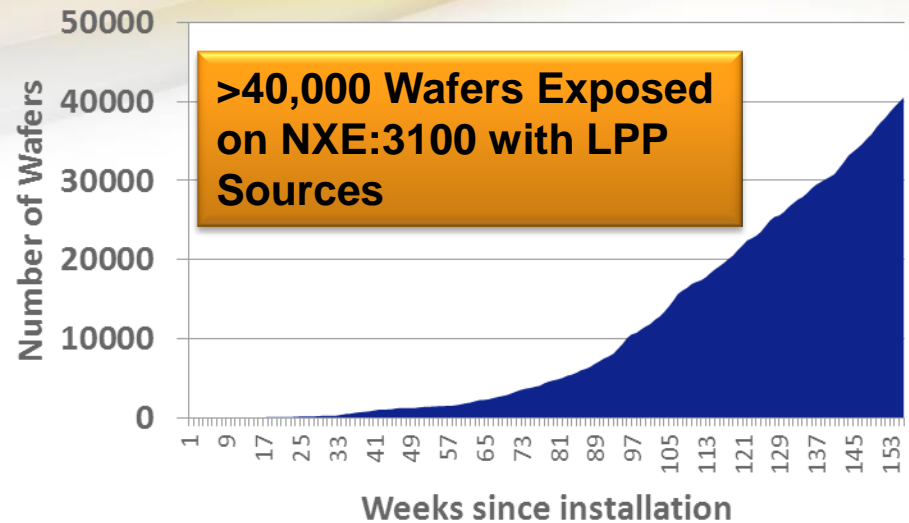
1. Field performance of NXE:3100 LPP Sources
2. Second Generation EUV Sources for NXE:3300B
3. In-Situ Collector Cleaning
4. Power Scaling
5. Roadmap and Summary

# Field performance of NXE:3100 LPP Sources

**CYMER**

# INSTALLED BASE OF NXE:3100 SOURCES

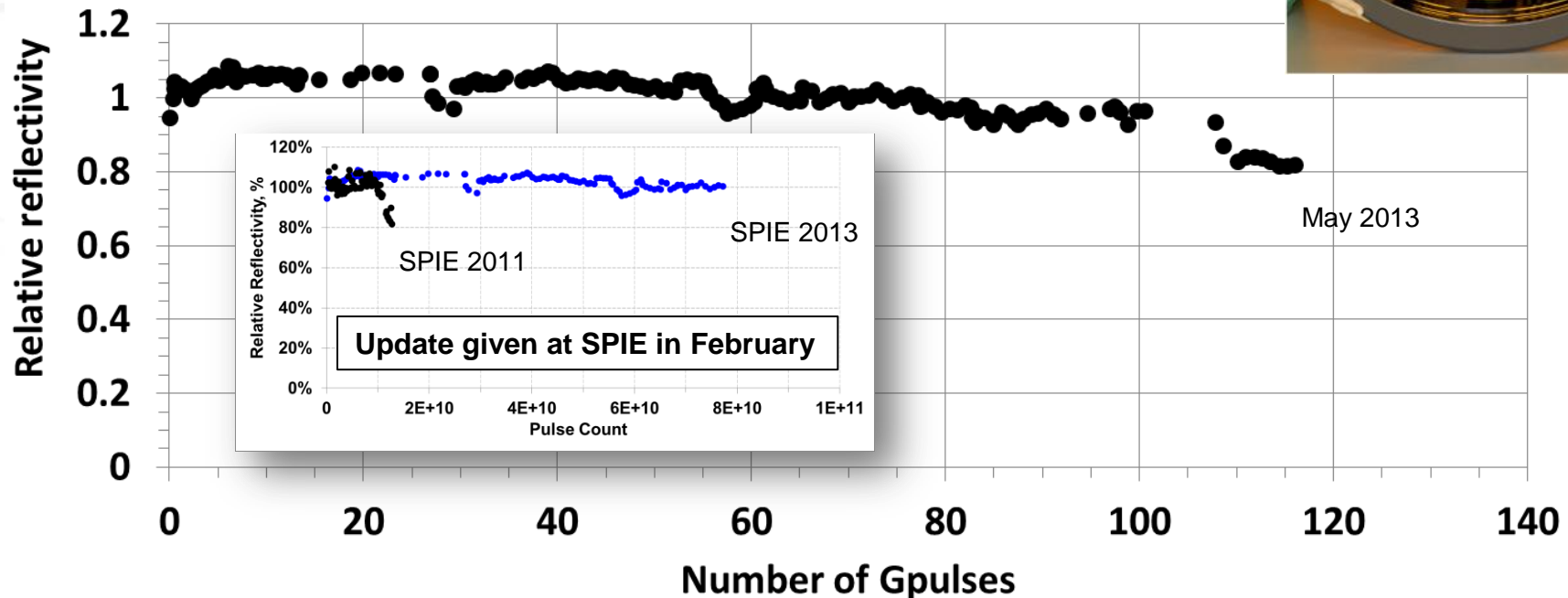
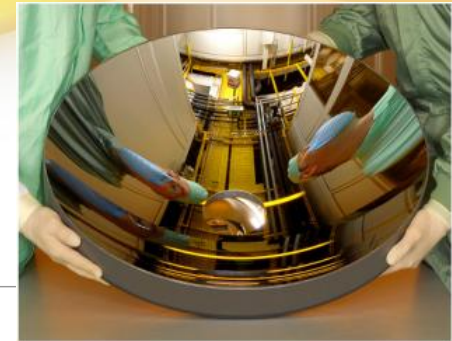
- **Total of 10 NXE:3100 sources are installed and operational**
  - 5 sources installed and exposing wafers at chipmaker development fabs for 2.5 yrs
    - ~100 wafer per day capability
    - $<\pm 0.5\%$  dose stability
  - 5 sources in San Diego and Veldhoven for MOPA+PP development, and for technology transfer to NXE:3300B
- **Maintaining up to ~70% source availability in 2013**
  - Average of 5 customer sources
  - Plans in place to improve to 75% by year end



# NXE:3100 Collector Lifetime in the Field

**Champion lifetime in the field ~11 months  
(~120 billion pulses)**

**Six collectors with >6 months lifetime**

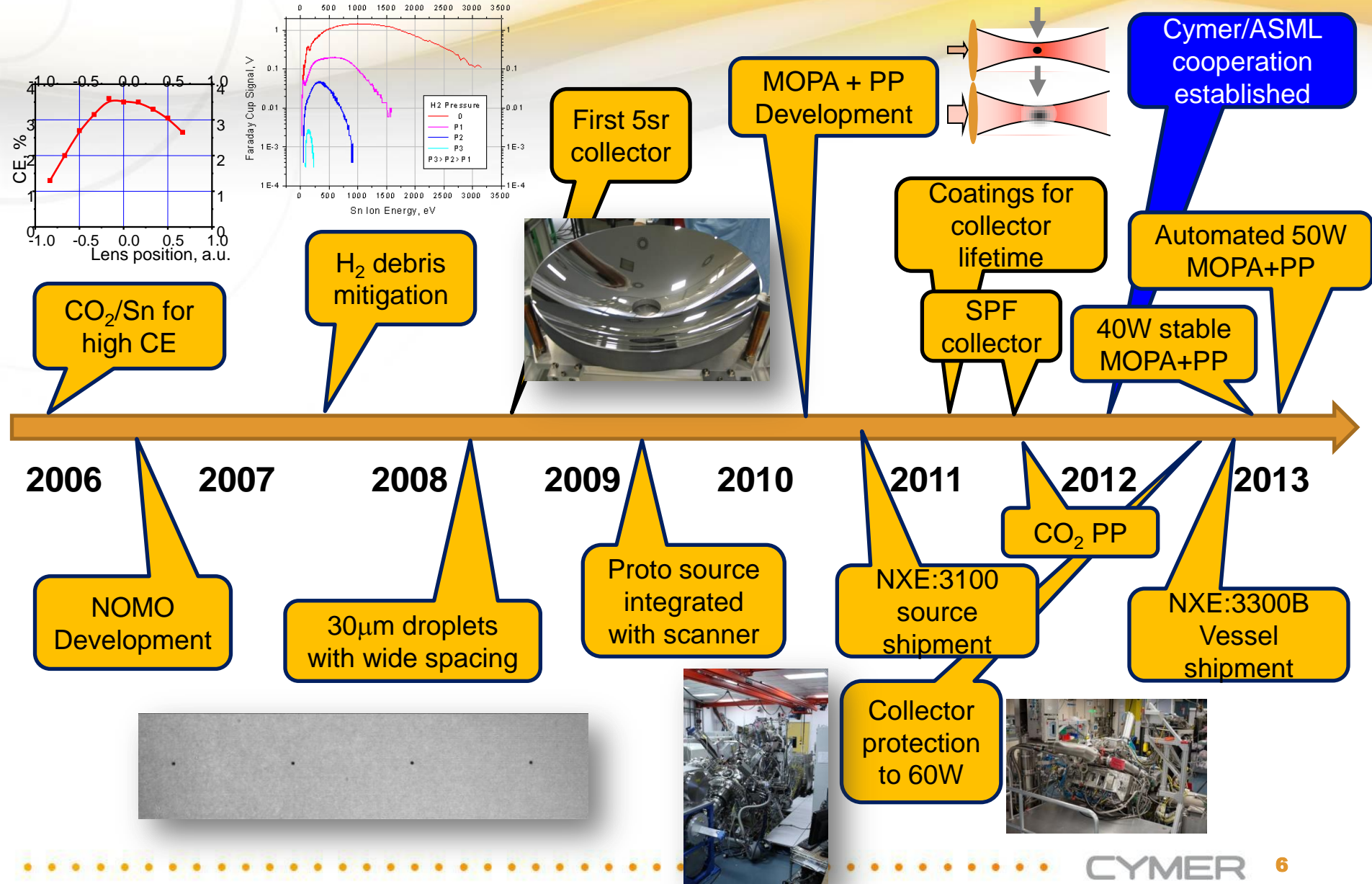


Type	Average Lifetime (sample size)	Best lifetime
Uncapped	7 Gp (8)	15 Gp (1)
<b>Current Cap Layer</b>	<b>42 Gp (19, 5 still going)</b>	<b>120 Gp (1)</b>

Cap layer development has enabled increased average collector lifetime by >5X since initial installations



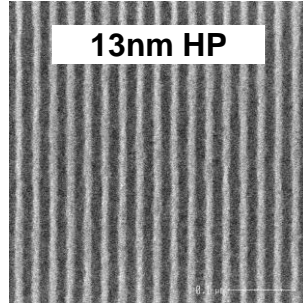
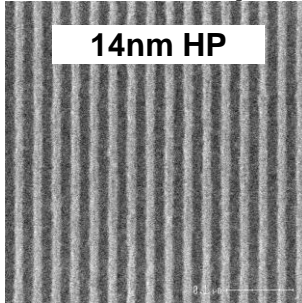
# Our LPP Source Development History



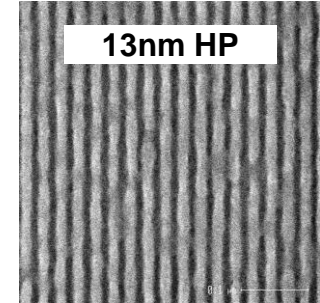
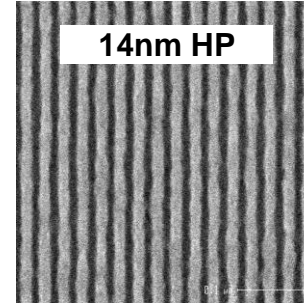
# NXE:3300B Resolution for Dense L/S and CH

*Single exposure structures with LPP Source*

**Dipole45, Inpria Resist**

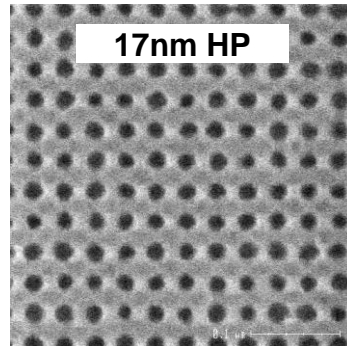
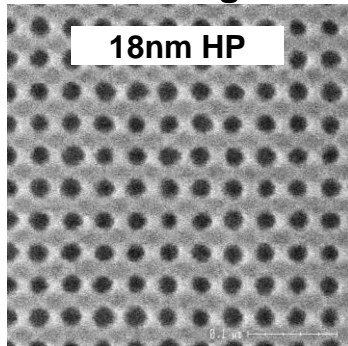


**Dipole30, Chemically Amplified Resist (CAR)**

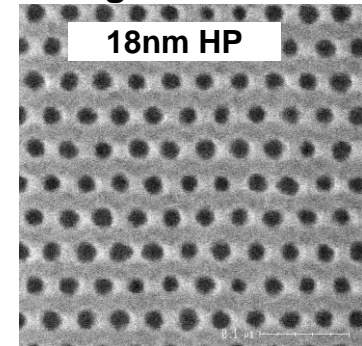
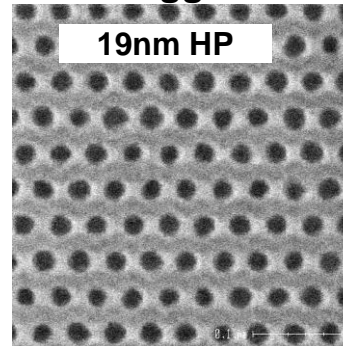


## 13nm HP with single exposure on NXE:3300B

**Regular CH @ Quasar 30**



**Staggered CH @ Large Annular**



## Dense CH imaging achieved down to 17nm HP on NXE:3300B

# **Second Generation EUV Sources for NXE:3300B**

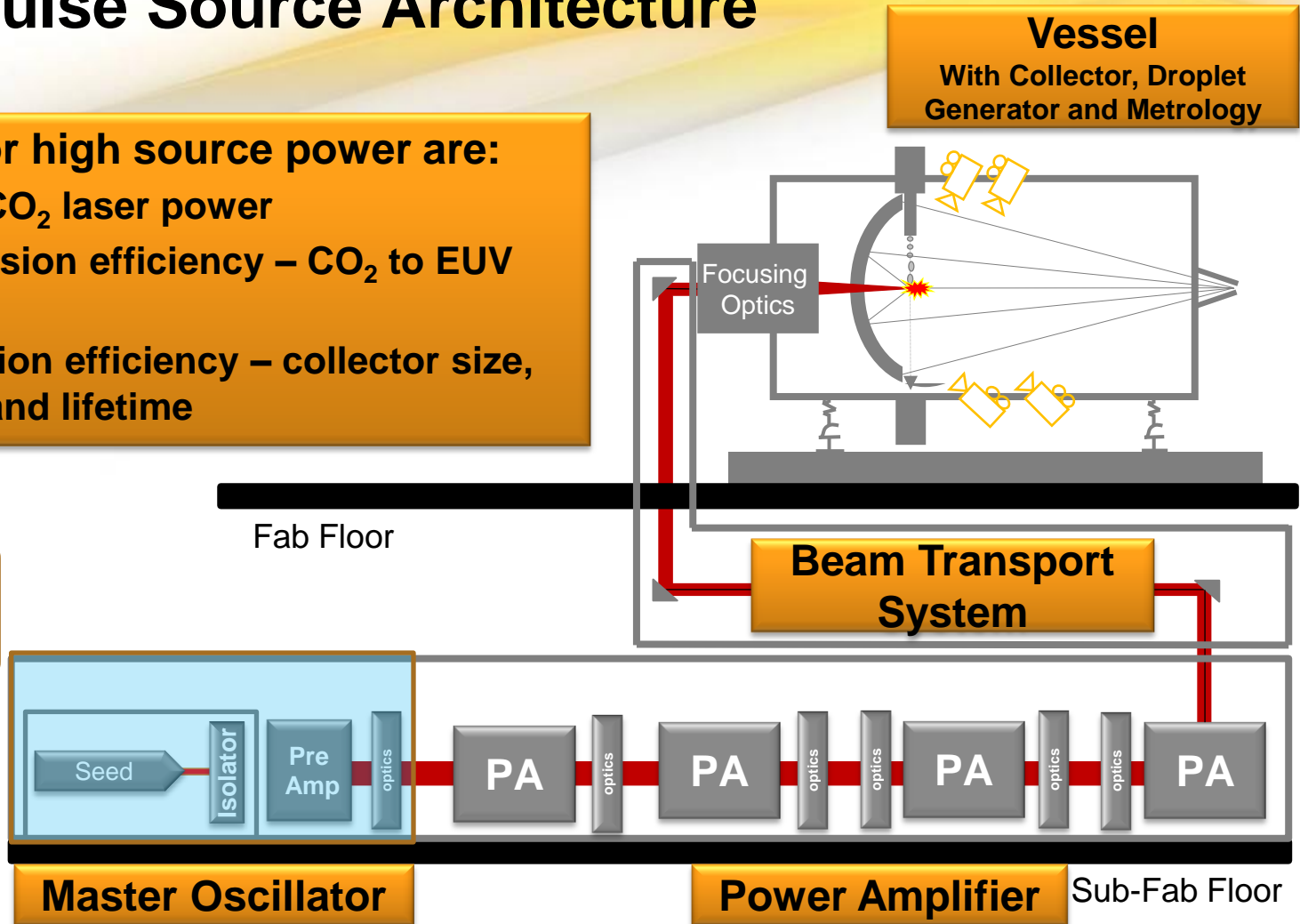
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# MOPA Prepulse Source Architecture

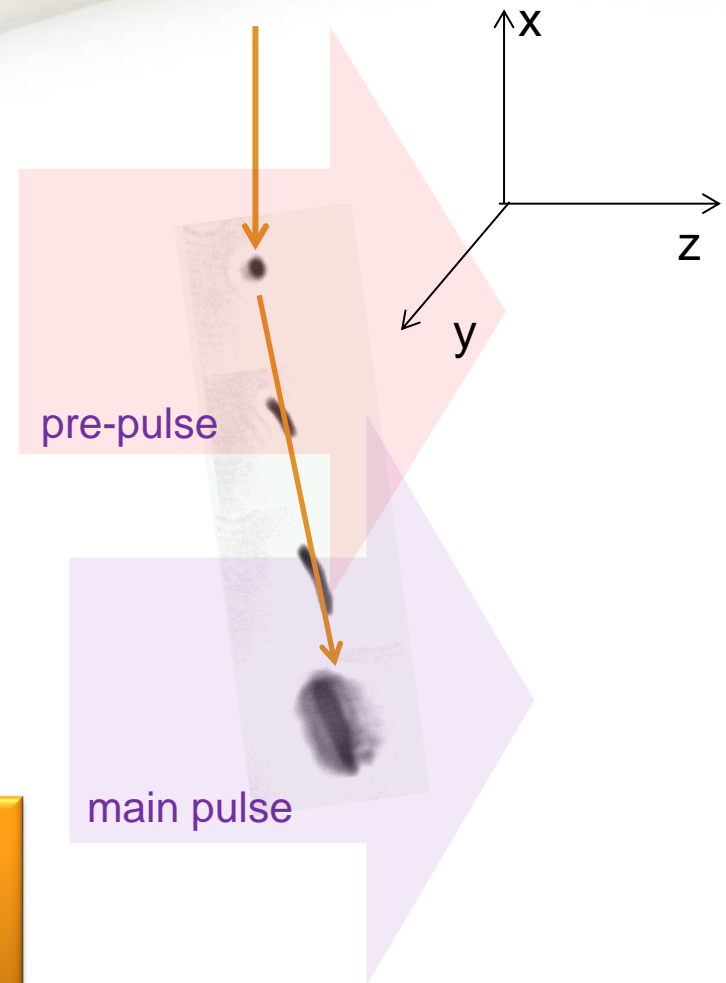
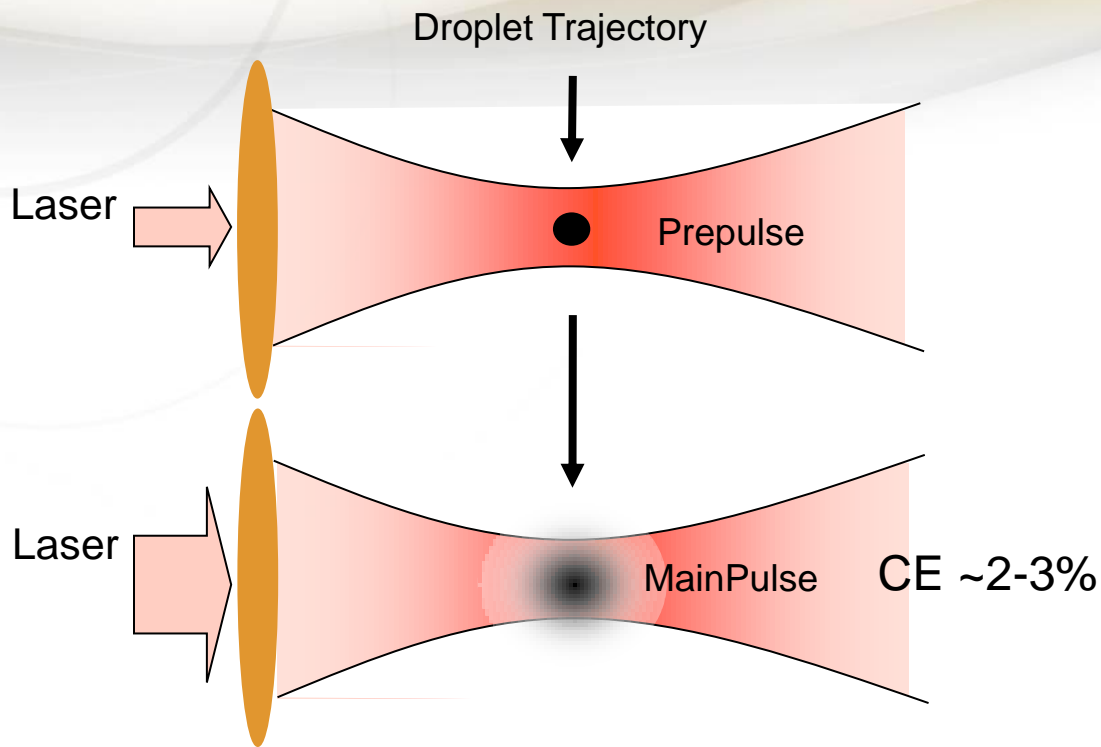
- Key factors for high source power are:
  - High input CO<sub>2</sub> laser power
  - High conversion efficiency – CO<sub>2</sub> to EUV energy
  - High collection efficiency – collector size, reflectivity and lifetime

Seed Laser



**MOPA - Master Oscillator Power Amplifier**

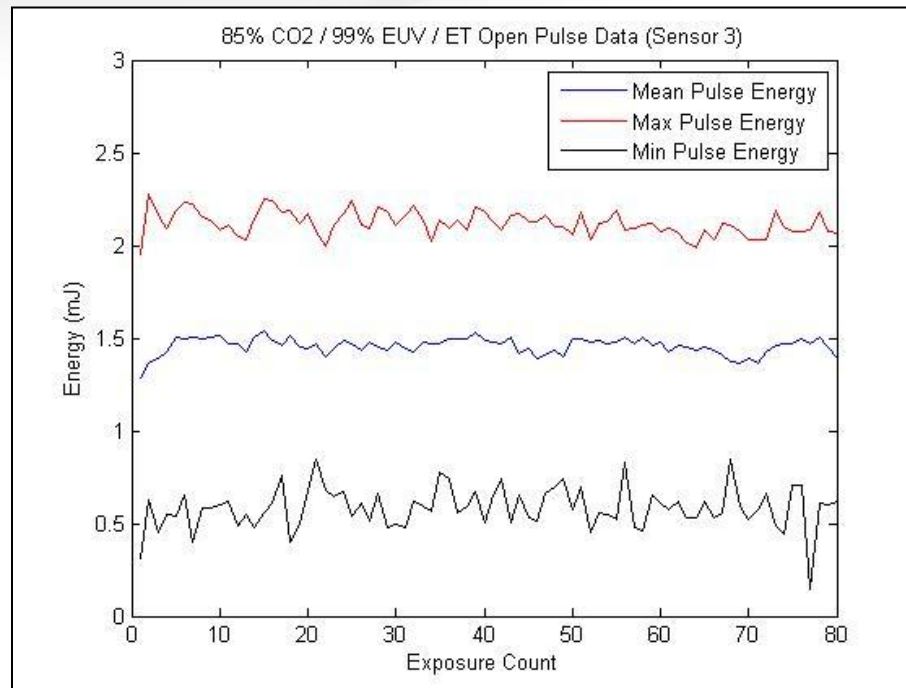
# Pre-pulse – Key To Scaling EUV Power



- Target conditioning provides better overlap of the CO<sub>2</sub> main pulse beam with the target material

# NXE:3300B Source Qualification Progress in MOPA Prepulse: 60W Open Loop Power

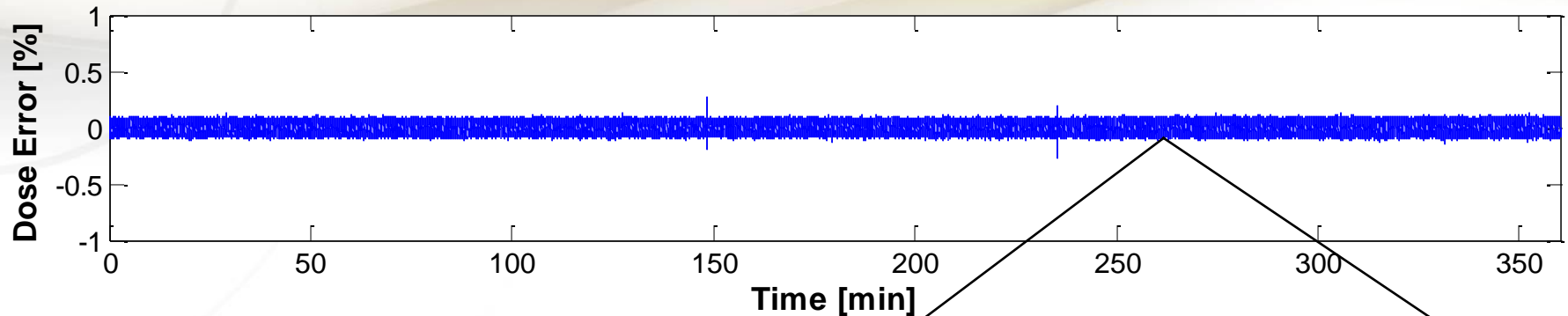
60W (open loop)



- 50kHz repetition rate
- Initial dose control results shown, dose margin will be improved after full controls are applied

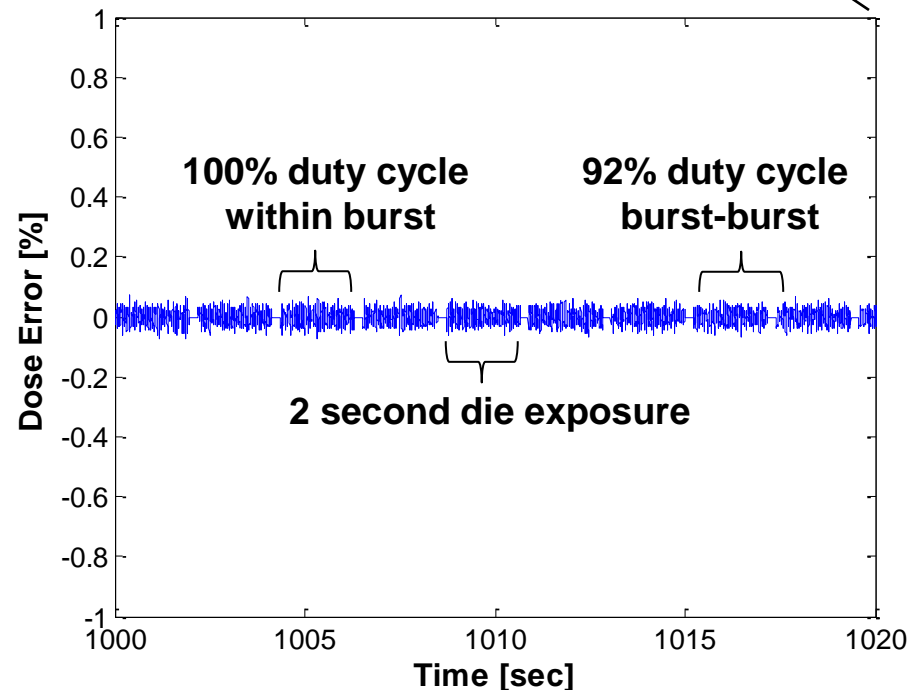
# MOPA Prepulse Performance at 40W

*Exceptional Dose Stability  $<\pm 0.5\%$*



## Operating Conditions

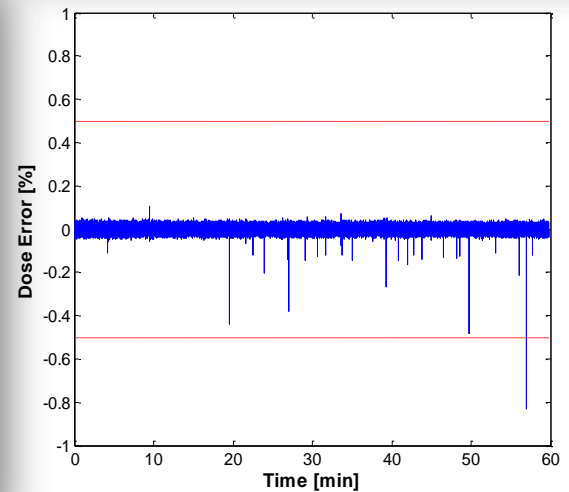
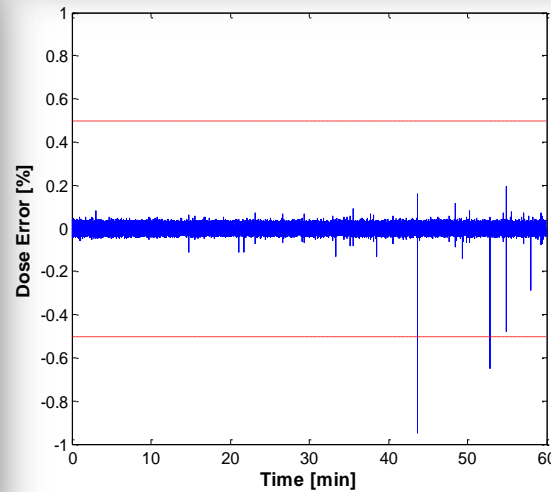
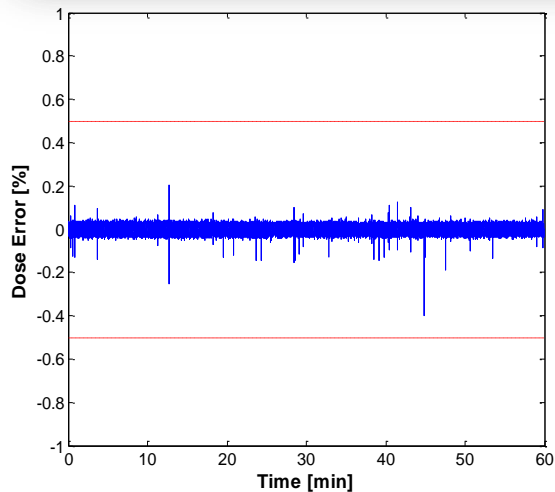
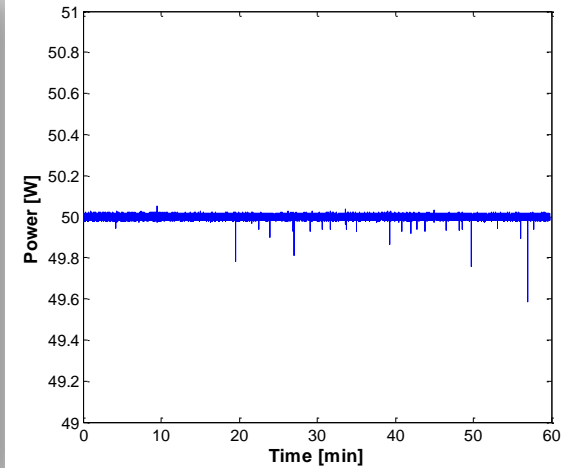
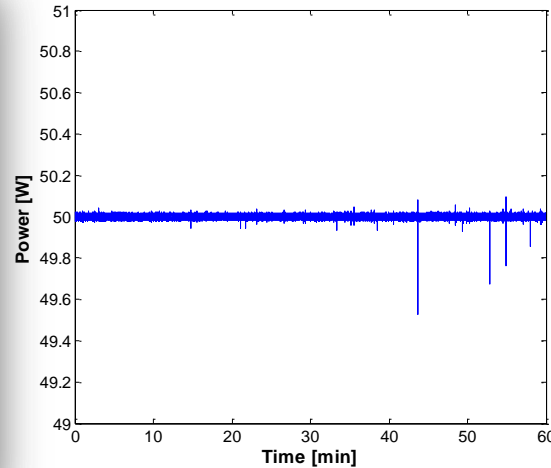
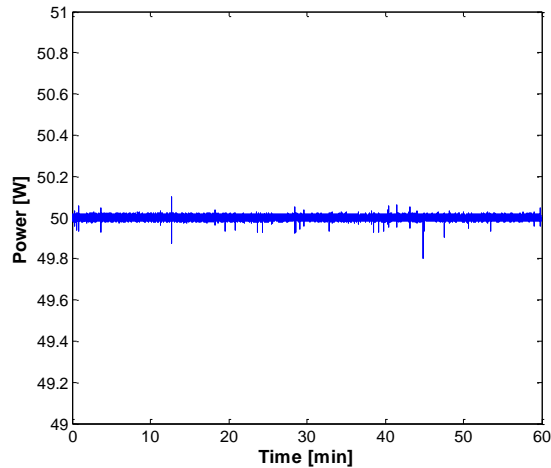
- Prepulse
- 50kHz Rep Rate
- 2 second die exposures
- 100% duty cycle within the burst, 92% burst to burst
- Closed loop control in x, y, z, E and t



Data collected on NXE:3100 source in San Diego

# 50W MOPA Prepulse EUV Power and Dose Stability

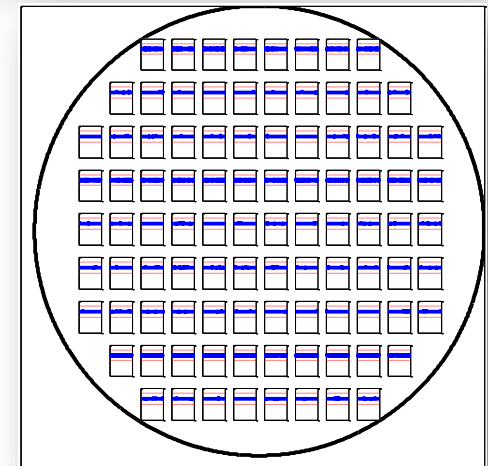
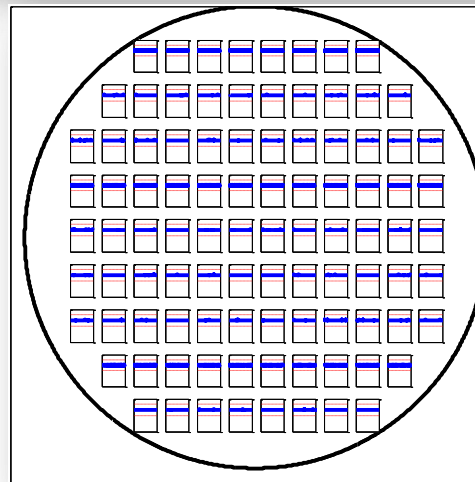
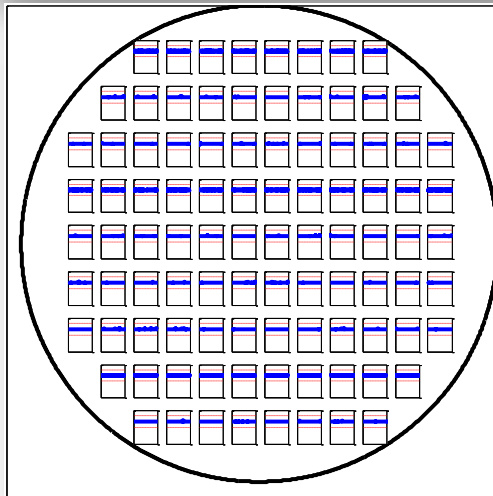
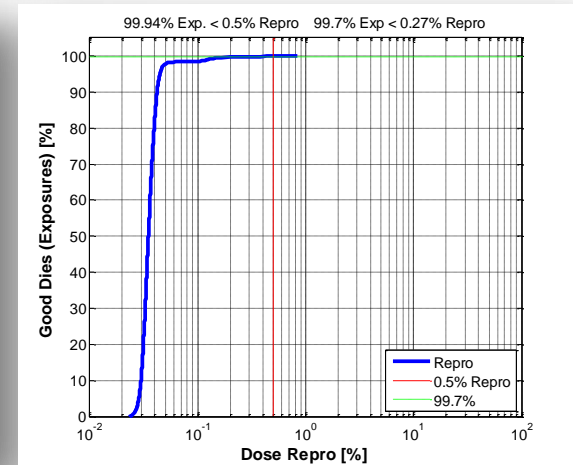
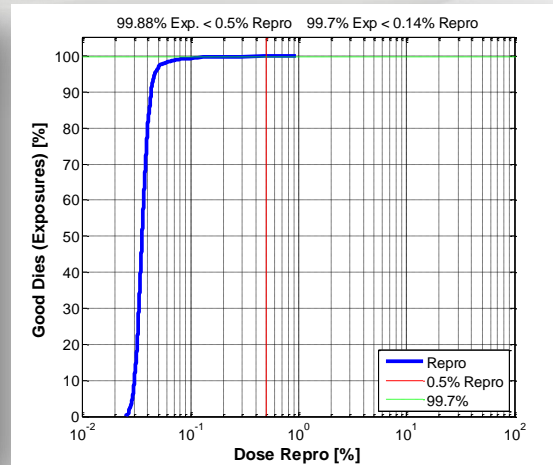
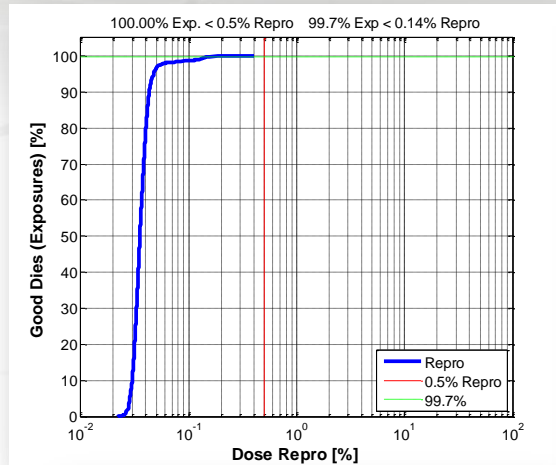
*Dose Stability  $< \pm 0.5\%$ , Die Yield  $> 99.7\%$*





# 50W MOPA Prepulse Die Yield

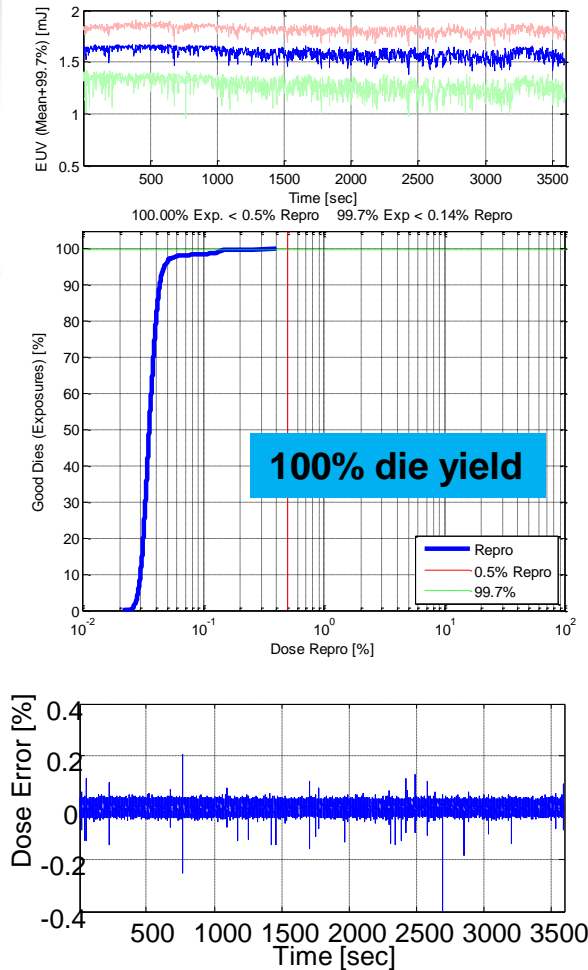
*Die Yield Exceeds 99.7%, three runs of 1 hour each*



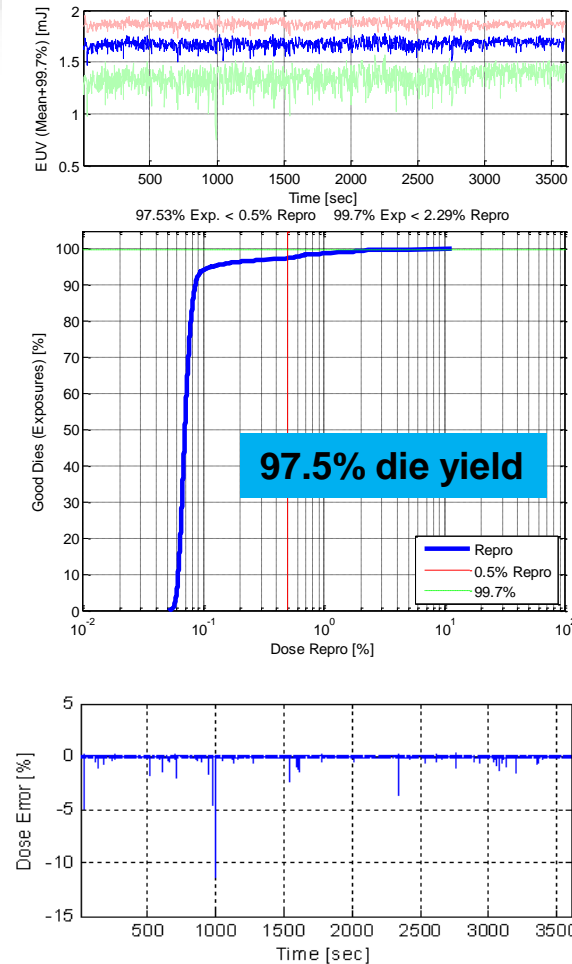
Data collected on NXE:3100 source in San Diego

# MOPA Prepulse Power with Closed Loop Control up to 55W Demonstrated on P9 NXE:3100 at Cymer

## 50W

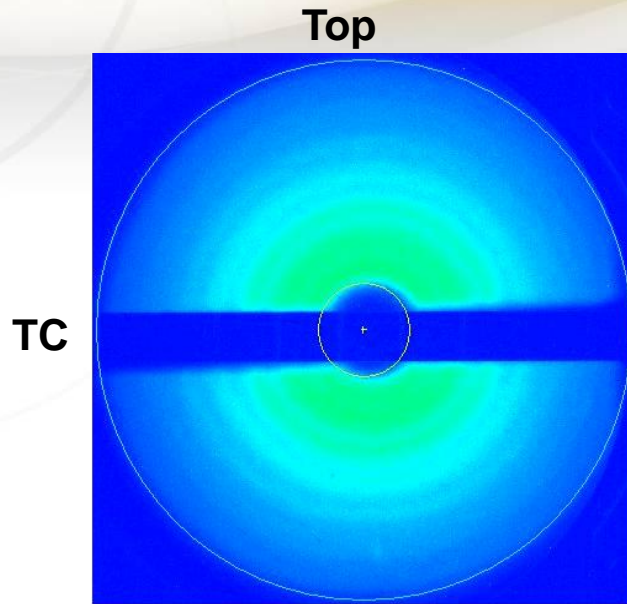


## 55W

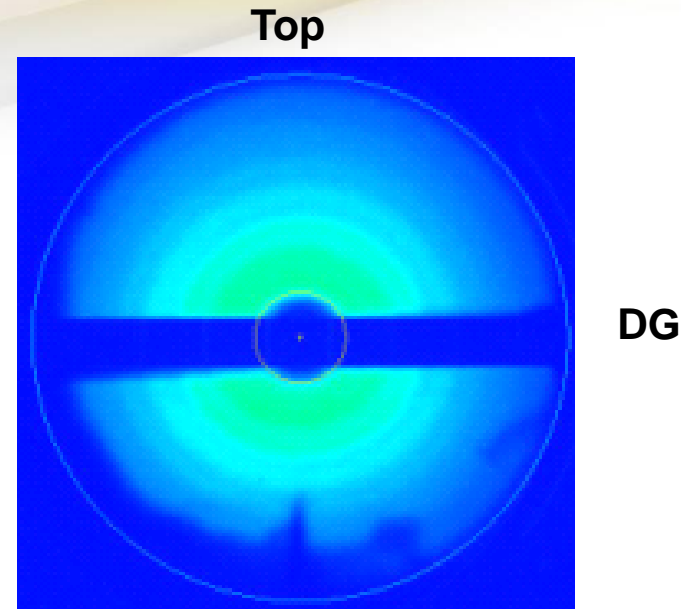


# MOPA Prepulse Collector Protection NXE:3100 Source

## *Collector Protection to 15 Billion Pulses Demonstrated*



Bottom  
1.2 Mpulses  
 $R/R_0 = 100\%$



Bottom  
15 Gpulses  
 $R/R_0 \sim 95\%$

- **Operating conditions at 40W**
  - 50kHz Rep Rate
  - 2 sec die exposures, 100% DC within the burst, 92% burst to burst
  - Closed loop control in x, y, z, E and t

• **Collector Protection to 15 Gp without significant loss of reflectivity demonstrated**

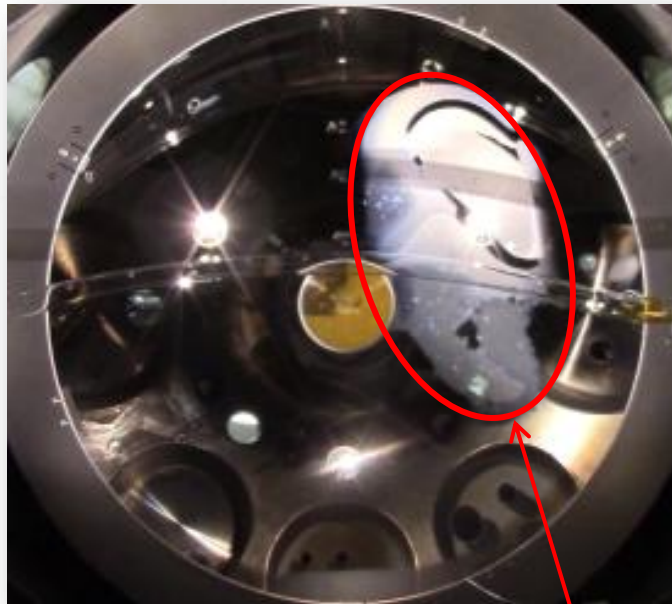
# In-Situ Collector Cleaning

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# In-situ Collector Cleaning Demonstrated

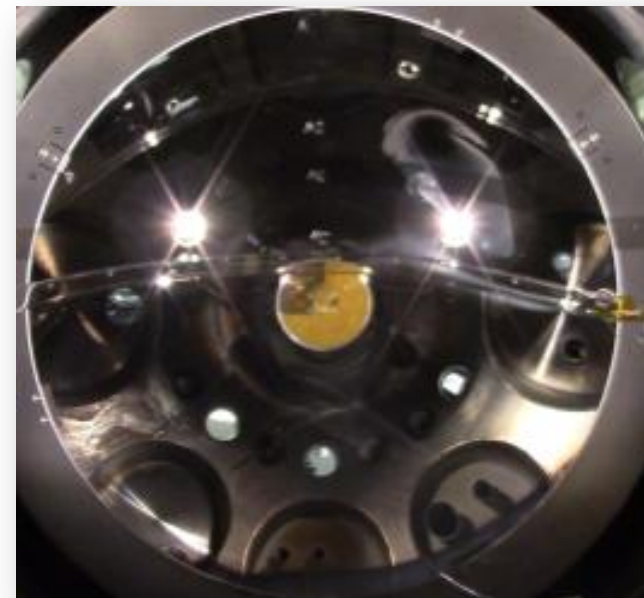
*Game changing technology for Uptime and COO*

- **Cleaning on standard MLM capped NXE:3100 Collector**
  - Tin deposited during normal EUV operation was removed



- **Start of test**

Area to be cleaned



- **Collector after cleaning in-situ (in the vessel)**



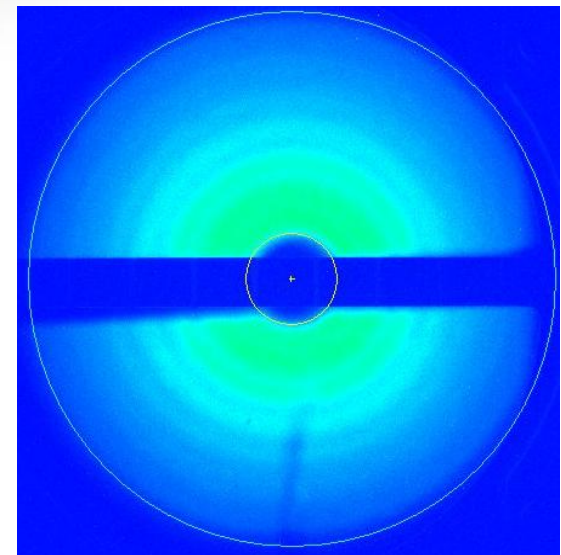
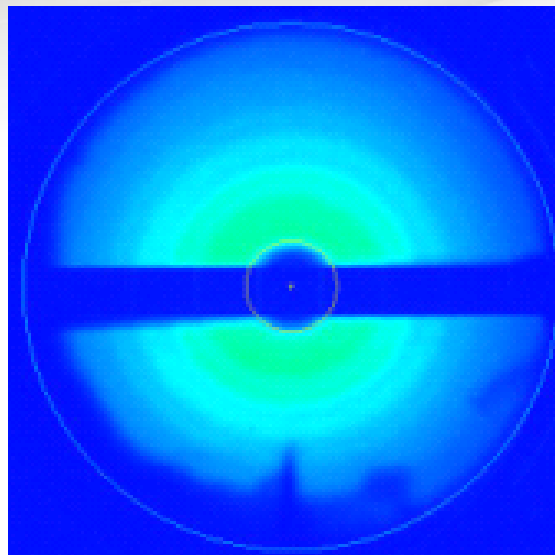
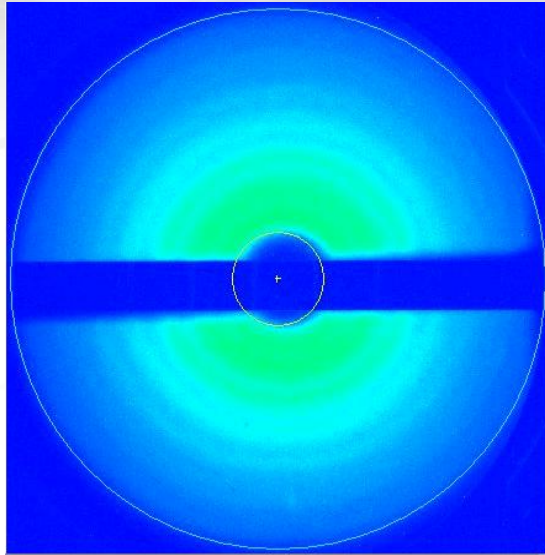
# MOPA Prepulse Collector Protection NXE:3100 Source

## *Collector Cleaned at 15 Billion Pulses*

Top

Top

Top



Bottom

Bottom

Bottom

1.2 Mpulses

$R/R_0 = 100\%$

15 Gpulses

$R/R_0 \sim 95\%$

After cleaning (15 Gp)

$R/R_0 \sim 100\%$

- Operating conditions at 40W
  - 50kHz Rep Rate
  - 2 sec die exposures, 100% DC within the burst, 92% burst to burst
  - Closed loop control in x, y, z, E and t

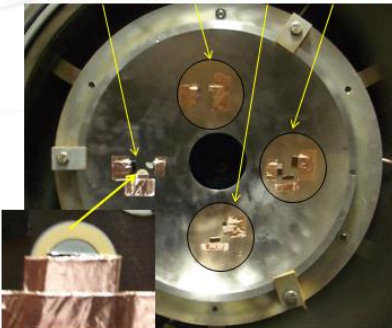
• In-situ cleaning demonstrated recovery of original reflectivity

# Collector Cleaning using RF Plasma

- Cymer funded project with University of Illinois at Urbana – Champaign
- Demonstrated 200nm Sn cleaning from Si sample placed on collector surface
- Demonstrated 25nm Sn cleaning from the entire 300mm dummy LT-1 collector

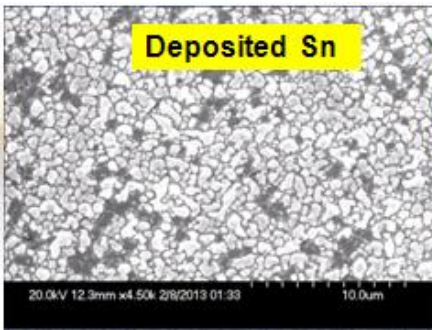
## 200nm Sn cleaning from Si samples placed on collector surface

200nm Sn and 50nm Sn coated Si samples were installed at various locations on the collector

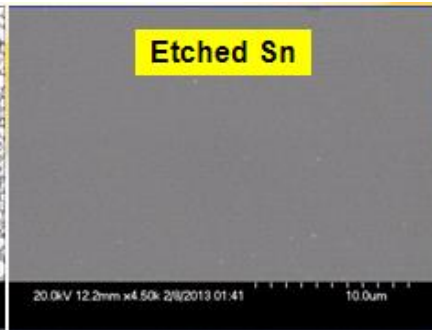


200nm Sn coated QCM was also placed on the collector

Deposited Sn

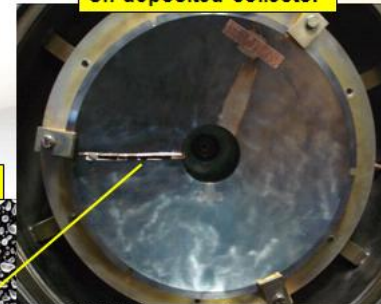


Etched Sn

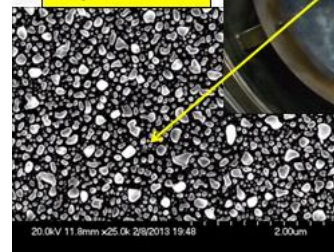


## 25nm Sn cleaning from 300mm dummy collector

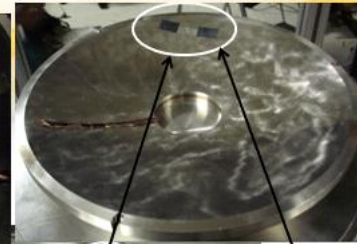
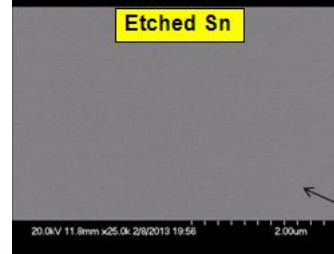
Sn deposited collector



Deposited Sn



Etched Sn



After removing the Cu tape, the Sn underneath is visible. The entire collector was this "blue" color after Sn deposition.

Cleaned collector

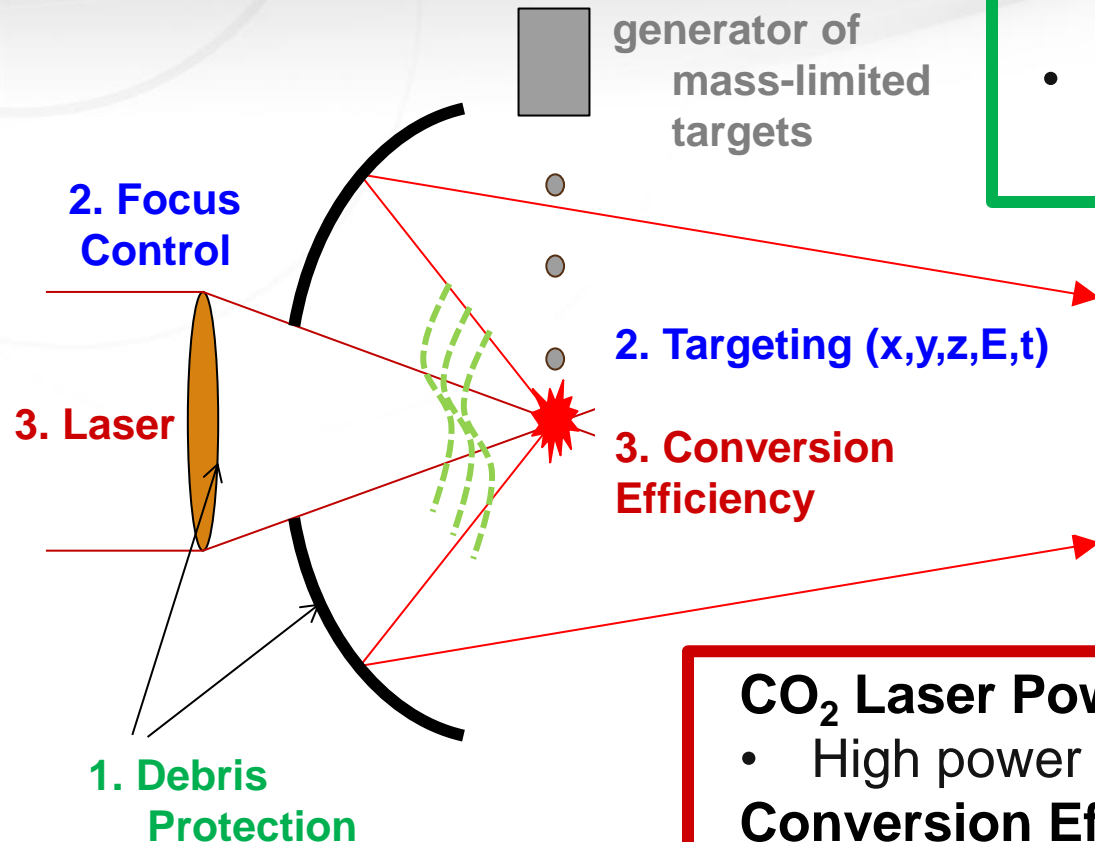
SEM was performed on one of samples to make sure that cleaning did happen

# Power Scaling

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# EUV Power Scaling

## Top Technology Challenges



### Optics Protection

(Debris Management)

1

- Collector protection by  $H_2$
- In-situ collector cleaning
- Collector capping layers

**Availability / CoO**

### Targeting Dynamics

2

- Target conditioning
- Focus Control
- x,y,z, E & t control

**Dose Control / Yield**

### CO<sub>2</sub> Laser Power

- High power drive laser

### Conversion Efficiency

- Prepulse

**EUV Power / Throughput**

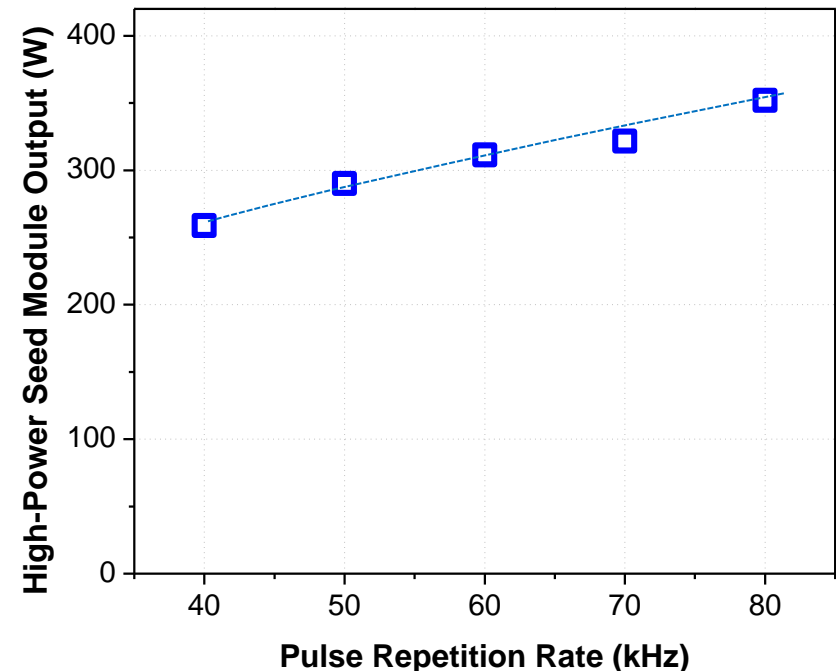
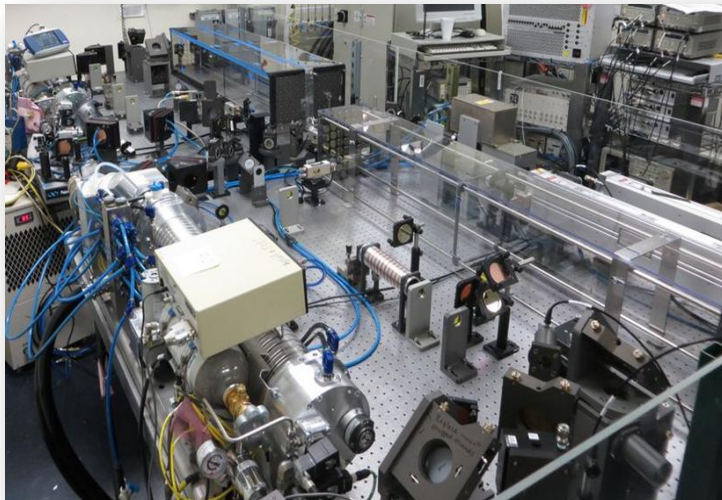
3



# High Power Seed Laser is Key to the Drive Laser

## *350W at 80kHz Demonstrated*

- Seed Laser power delivery to the amplifiers is critical to achieving saturation and maximum power extraction from the amplifiers
- 350W target design power at 80 kHz repetition rate
  - Already achieved in system-level bench testing





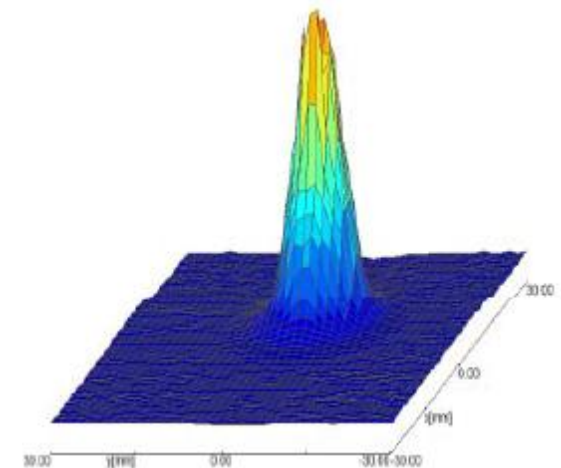
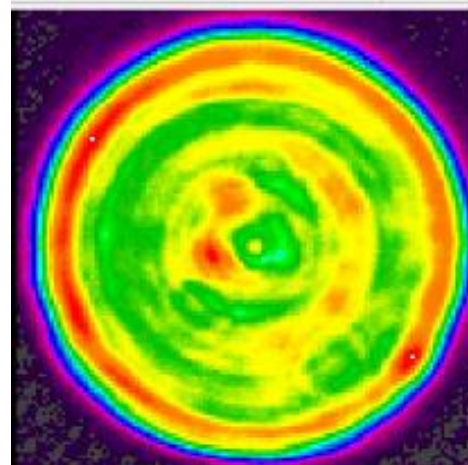
# New Amplifier for Increase Power is Operational

*Reached maximum of 35kW with good laser mode profile*

- Higher power amplifier development completed at supplier
- Repeatable, stable operation up to 35kW (increased from 20kW)
  - Single amplifier continuous (cw) output power
- Good beam quality measured → good focusability



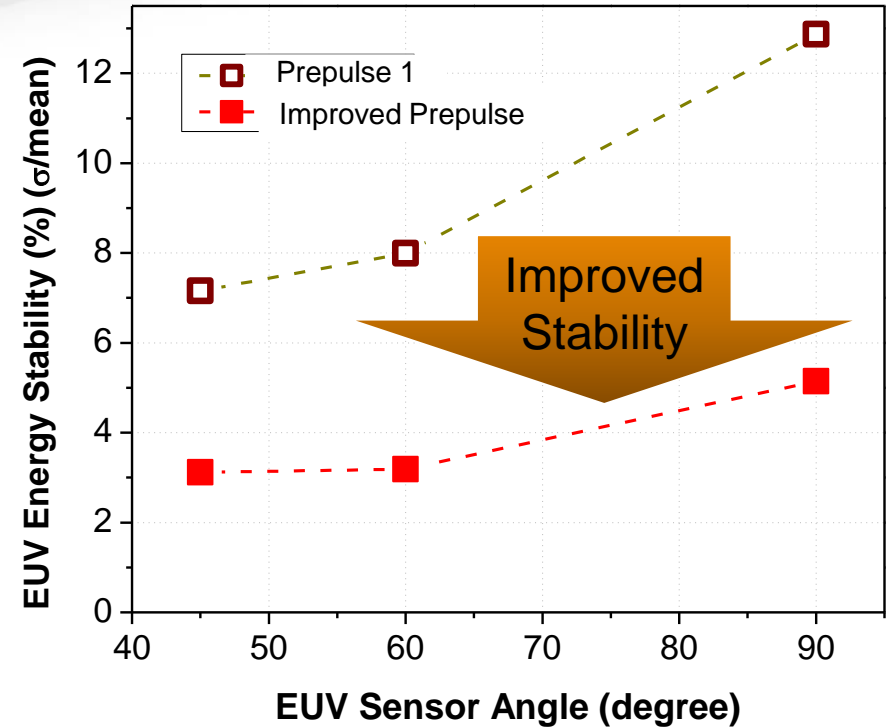
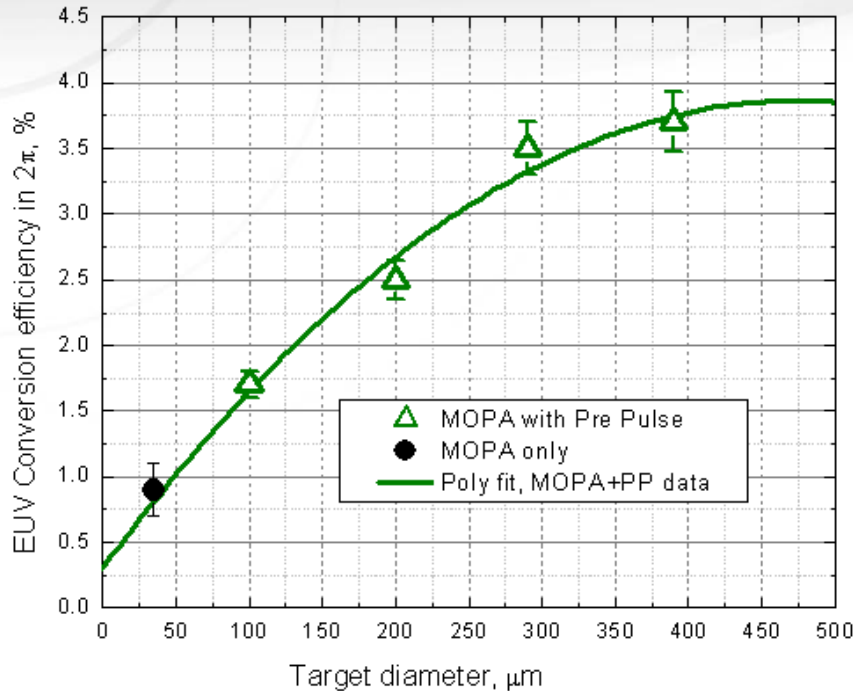
**35kW cw**



**Good beam quality**

# MOPA Prepulse Technology for High Power Sources

*Improved Prepulse shows 3.7% CE, driven by target size and stability (droplet and expanded target)*



## LT1 EUV power at low DC

**720W in  $2\pi$**



**176W raw at IF**



**140W at IF**

*(calc dose controlled)*

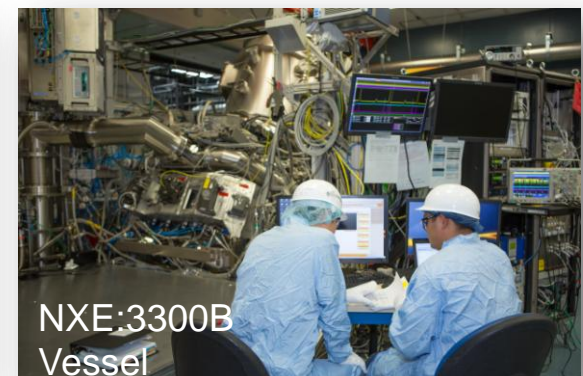
# Roadmap and Summary

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# EUV Source Power Roadmap

*Power Scaling with Increased CO<sub>2</sub> Laser Power and Conversion Efficiency*

	NXE:3100	NXE:3300B	NXE:3300B	NXE:3300B
EUV dose controlled power (in-burst)	50W	80W	125W	250W
Drive Laser	15kW	26kW	33kW	47kW
CE	>2%	3.0%	3.0%	3.3%



NXE:3100 Sources: Now in global field support phase

NXE:3300B Sources: Deliveries to Chipmakers in process



# Summary

- Five NXE:3100 sources operating in the field for >2.5 years → 40,000 wafers cycled through R&D organizations
- Multiple NXE:3100 sources operational in MOPA Prepulse for early learning and technology transfer to NXE:3300B program
- Multiple NXE:3300B sources operational in MOPA Prepulse in San Diego and Veldhoven for system qualification
- 50W source power with exceptional dose stability demonstrated on multiple test runs over many days of operation
- Collector protection demonstrated over 15 billion pulses in MOPA Prepulse mode of operation
- In-situ collector cleaning capability demonstrated to increase uptime and reduce COO



# Acknowledgements

*Thank you!*

**ASML**

**ZEISS**



**PTB**



**optiX fab.**



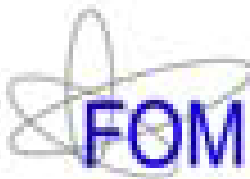
**Colorado  
State  
University**



**TRUMPF**



**TNO** innovation  
for life



# CYMER

Leading the Light Generation.

An **ASML** company